



Specification for LCD Module

AFY1024600A3-7.0INTH-C

Revision N



A	Orient Display
FY	TFT Type
1024600	Resolution 1024 x 600
A3	Serial A3
7.0	7.0", Module Dimension 165.0x100.0x7.55mm
I	IPS Display
N	Top: -20~+70°C; Tstr: -30~+80°C
T	Transmissive
H	High Brightness, 800 cd/m ²
C	Capacitive Touch Panel
/	Controller EK79001HF3-S + EK73215BCGA Or Compatible
/	Cap. Touch Panel Controller GT911
/	LVDS Interface



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
O	2019-10-10	First release	Preliminary
A	2019-11-06	CHANGED FPC AND LENS.Detail as in page 6 th .	
B	2019-11-12	CHANGED IC.Detail as in page 6 th .	
C	2020-02-14	CHANGED BACKLIGHT AND LENS.Detail as in page 6 th .	
D	2020-02-21	Add timing table. Detail as in page 12 th .	
E	2020-03-16	Update 6.EXTERNAL DIMENSIONS Detail as in page 6 th	
F	2020-05-04	Update EXTERNAL DIMENSIONS in page 6	
G	2020-05-23	Update ELECTRO-OPTICAL CHARACTERISTICS in page 7	
H	2020-07-21	Change the description of 25PIN in page 10	
I	2021-06-20	Update CUSTOMER NO. in page 6	
J	2021-08-09	Update the pin 6 of LCM INTERFACE DESCRIPTION	Page 10
K	2022-4-1	Update ABSOLUTE MAXIMUM RATINGS Update ELECTRICAL CHARACTERISTICS	Page 3 Page 4
L	2023-03-30	Update GENERAL INFORMATION	Page 4
M	2023-07-27	Update the pin 30 of LCM INTERFACE DESCRIPTION	Page 10
N	2024-09-25	Update CUSTOMER NO. Update GENERAL INFORMATION Update ABSOLUTE MAXIMUM RATINGS Update EXTERNAL DIMENSIONS	Page 1 Page 4 Page 4 Page 6

CONTENTS

1. GENERAL INFORMATION.....	4
2. ABSOLUTE MAXIMUM RATINGS.....	4
3. ELECTRICAL CHARACTERISTICS.....	5
4. BACKLIGHT CHARACTERISTICS.....	5
5. TOUCH PANEL CHARACTERISTICS.....	5
6. EXTERNAL DIMENSIONS.....	6
7. ELECTRO-OPTICAL CHARACTERISTICS.....	7
8. INTERFACE DESCRIPTION.....	10
9. AC CHARACTERISTICS.....	11
10. POWER SEQUENCE.....	17
11. RELIABILITY TEST CONDITIONS.....	18
12. INSPECTION CRITERION.....	19
13. HANDLING PRECAUTIONS.....	19
14. PRECAUTION FOR USE.....	20
15. PACKING SPECIFICATION.....	20

1.GENERAL INFORMATION

No.	Item	Contents	Unit
1	LCD size	7.0 inch (Diagonal)	/
2	LCD type	IPS/Normally Black/TRANSMISSIVE(ANTI-GLARE)	/
3	Viewing direction(eye)	Free	/
4	Resolution(H*V)	1024 *600 Pixels(TFT)/ 1024 *600 Dots(CTP)	/
5	Module size (L*W*H)	165.0*100.0*7.55	mm
6	Active area (L*W)	154.21*85.92	mm
7	Pixel pitch (L*W)	0.1506* 0.1432	mm
8	Interface type	LVDS Interface	/
9	Module power consumption	4.905	W
10	Back light type	White LED	/
11	Driver IC	EK79001HF3-S+EK73215BCGA or COMPATIBLE(TFT) GT911(CTP)	/
12	Weight	TBD	g

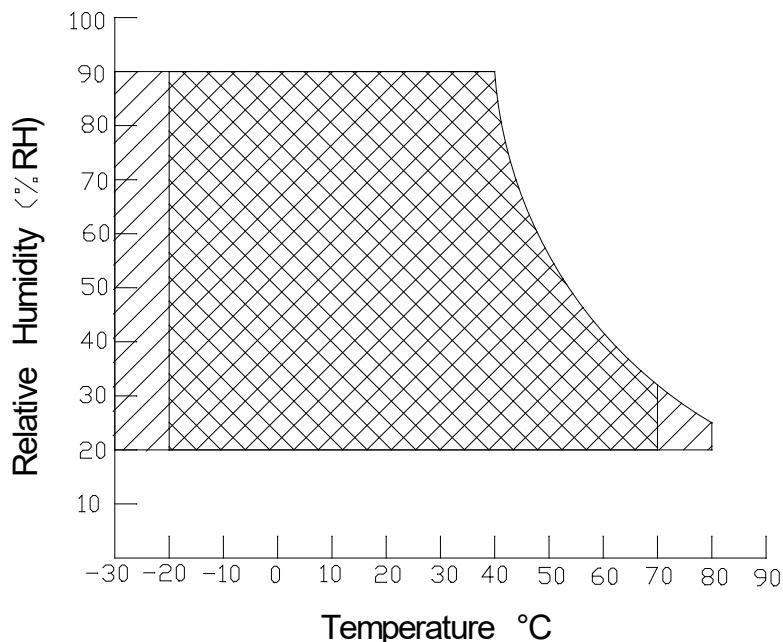
2. ABSOLUTE MAXIMUM RATINGS

Item	Sym bol	Min.	Max.	Unit	Note
Power supply input voltage for TFT	VDD	-0.5	5.0	V	
Power supply input voltage for CTP	VDD	2.66	3.47	V	
Backlight current (normal temp.)	ILED	-	600	mA	
Operation temperature	Top	-20	+70	°C	Note1
Storage temperature	Tst	-30	+80	°C	Note1
Humidity	RH	20%	90%	/	Note1

Note1 :

1).The relative humidity and temperature range are as below sketch,90%RH Max.

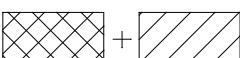
2).The maximum wet bulb temperature $\leq 40^{\circ}\text{C}$ and without dewing.



Operating Range



Storage Range



3. ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS(at Ta=25°C)

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Power supply input voltage	VDD	2.3	3.3	3.6	V	
I/O logic voltage	VDDIO	-	-	-	V	
Input voltage 'H' level	VIH	0.7VDD	-	VDD	V	
Input voltage 'L' level	VIL	VSS	-	0.3VDD	V	
Power supply current	IVDD	-	90	-	mA	
TFT gate on voltage	VGH	-	-	-	V	
TFT gate off voltage	VGL	-	-	-	V	
Analog power supply voltage	AVDD	-	-	-	V	
TFT common electrode voltage	VCOM	-	-	-	V	Note1

Note1 : The value is just the reference value. The customer can optimize the setting value by the different D-IC
Vcom must be adjusted to optimize display quality, as Crosstalk and Contrast Ratio etc..

CTP DC CHARACTERISTICS(at Ta=25°C)

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Power supply input voltage	VDD	3.1	3.3	3.3	V	Note2
Input Power ripple	Vpp	-	-	50	mV	
I/O Signal Voltage	VDDIO	-	1.8	-	V	Note2
Input voltage 'H' level	VIH	0.75VDDIO	-	VDDIO+0.3	V	
Input voltage 'L' level	VIL	-0.3	-	0.25VDDIO	V	
Operating Current (Normal Mode)	IVDD	-	8	-	mA	
Operating Current (Sleep mode)	IVDD	-	-	-	mA	

Note2 : If you need more information of CTP,please refer to our Spec of CTP.

4. BACKLIGHT CHARACTERISTICS

(at Ta=25°C, RH=60%)

Item	Symbol	Min.	Typ.	Max.	Unit	Note
LED forward voltage	VF	8.7	9.6	10.5	V	
LED forward current	IF	-	480	-	mA	IF=480mA
LED power consumption	PLED	-	4.608	-	W	Note1
Number of LED	-		24		PCS	
Connection mode	-	3 in series *8 in parallel			/	
LED life-time	-	20000	-	-	Hrs	Note2

Note1.Calculator Value for reference: IF*VF = PLED

Note2.The LED Life-time define as the estimated time to 50% degradation of initial brightness at Ta=25°C and IF =480mA. The LED lifetime could be decreased if operating IF is larger than 480mA

5. TOUCH PANEL CHARACTERISTICS (at Ta=25°C)

Item	Description	Remark
ProductStructure	G+G	
Surface Hardness	≤6H	Pencil, Loading 500g, 45 deg
Ball-falling Test	≤100cm	Steel ball weight 64g
Touch Count Max	5 point	
I2C Slave Address*	0x5D	
Origin of Coordinate*	top left corner	
FW version	TBD	

6. EXTERNAL DIMENSIONS

This technical drawing illustrates the assembly and pin definitions for an LCD display. It includes four views (A, B, C, D) and a large green 'ORIENT DISPLAY' logo.

View A: Shows the front and back views of the LCD assembly. The front view highlights the display area with a resolution of 7.0" (1024x600 pixels), a polarizer type of transmissive/anti-glare, and a polarizer thickness of 0.0043-0.0100 mm. The back view shows the TFT component with a thickness of 1.80 MAX (TFT component), a bending area of 10.00 mm, and a non-bending area of 2.00 mm. It also includes a label content area with a scale of 2:1.

View B: Provides a detailed cross-sectional view of the display assembly, showing the stack-up of the protective film, tape, and various components. It includes dimensions for the top protective film (1.80 mm), bending area (10.00 mm), and non-bending area (2.00 mm). A label content area is also present.

View C: Shows the TFT pin definition. It lists 20 pins with their corresponding symbols and descriptions. The pins include GND, VDD, VSS, VCOM, RST, SCL, SDA, LEDA, LEDB, and various logic and control pins.

View D: Shows the backlight driver circuit diagram. It includes a table of revision history and a list of components and their descriptions.

Large Logo: A large green 'ORIENT DISPLAY' logo is positioned in the center-right area of the drawing.

7. ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Typ	Max	Unit	Remark	Note
Response time	Tr+ Tf	-	-	25	50	ms	FIG.1	Note 4
Contrast ratio	Cr		500	650	-	---	FIG.2	Note 1
Surface Luminance	Lv	$\theta=0^\circ$	640	800	-	cd/m ²	FIG.2	Note 2
Luminance uniformity	-	$\theta=0^\circ$	75	85	-	%	FIG.2	Note 3
NTSC	-	$\theta=0^\circ$	-	52	-	%	FIG.2	Note 5
Viewing angle range	θ	$\emptyset = 90^\circ$	-	85	-	deg	FIG.3	Note 6
		$\emptyset = 270^\circ$	-	85	-	deg	FIG.3	
		$\emptyset = 0^\circ$	-	85	-	deg	FIG.3	
		$\emptyset = 180^\circ$	-	85	-	deg	FIG.3	
CIE (x, y) chromaticity	Red x	$\theta=0^\circ$ $\emptyset=0^\circ$ $Ta=25^\circ C$	Typ -0.04	0.60	Typ +0.04	-	FIG.2 CIE1931	Note 5
	Red y			0.35		-		
	Green x			0.31		-		
	Green y			0.58		-		
	Blue x			0.15		-		
	Blue y			0.11		-		
	White x			0.30		-		
	White y			0.33		-		

Note1. Definition of contrast ratio

Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG.2
Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5,P6,P7,P8,P9)

Contrast Ratio = Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5,P6,P7,P8,P9)

Note2. Definition of surface luminance

Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG.2

Lv = Average Surface Luminance with all white pixels(P1, P2, P3, P4, P5,P6,P7,P8,P9)

Note3. Definition of luminance uniformity

The luminance uniformity in surface luminance (δ WHITE) is determined by measuring luminance at each test position 1 through 9, and then dividing the maximum luminance of 9 points luminance by minimum luminance of 9 points luminance. For more information see FIG.2

Minimum Surface Luminance with all white pixels (P1, P2, P3, P4, P5,P6,P7,P8,P9)

Maximum Surface Luminance with all white pixels (P1, P2, P3, P4, P5,P6,P7,P8,P9)

Note4. Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%. For additional information see FIG1.

Note5. Definition of color chromaticity (CIE1931)

CIE (x, y) chromaticity ,The x,y value is determined by screen active area center position P5,For more information see FIG.2

Note6. Definition of Viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3

For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on TOPCON's BM-5or BM-7 photo detector or compatible.

Note: For TFT module, Gray scale reverse occurs in the direction of panel viewing angle. **The definition of Response Time**

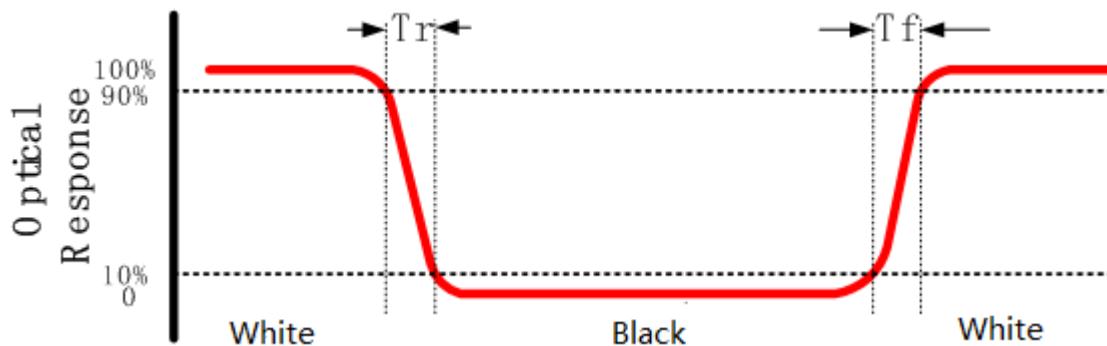


FIG.1. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

Size:S≤5"(see Figure a)

A : 5 mm B : 5 mm

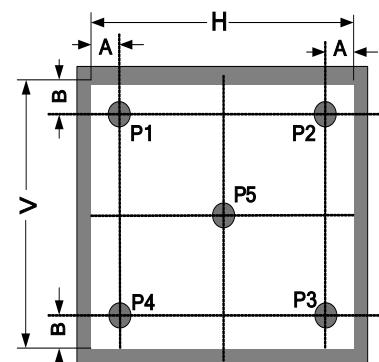
H,V : Active Area

Light spot size $\varnothing=5\text{mm}$ (BM-5) or $\varnothing=7.7$

(BM-7)50cm distance or

compatible distance from the LCD surface to detector lens.

test spot position: see Figure a.



measurement instrument : TOPCON's luminance meter BM-5 or BM-7 or compatible (see Figure c)

Figure a

Size: 5" < S ≤ 12.3" (see Figure b)

H, V : Active Area

Light spot size $\varnothing=5\text{mm}$ (BM-5) or $\varnothing=7.7\text{mm}$ (BM-7) 50cm distance or compatible distance from the LCD surface to detector lens

test spot position: see Figure b

measurement instrument : TOPCON's luminance meter BM-5 or BM-7 or compatible (see Figure c)

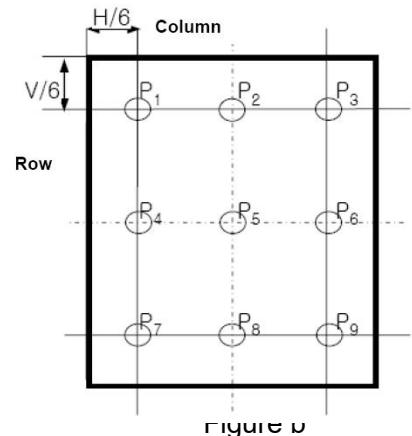
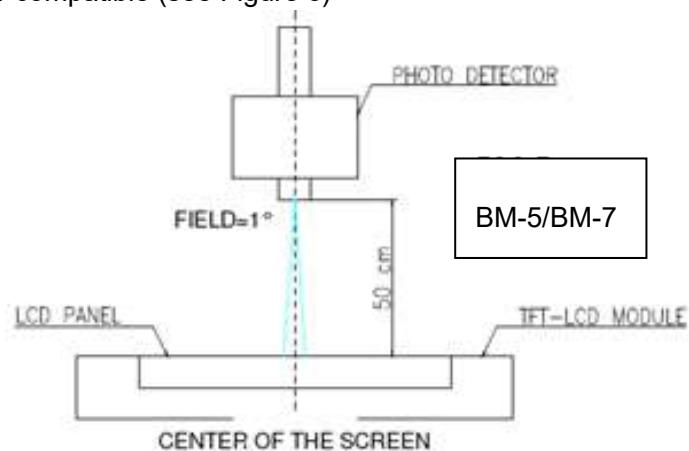
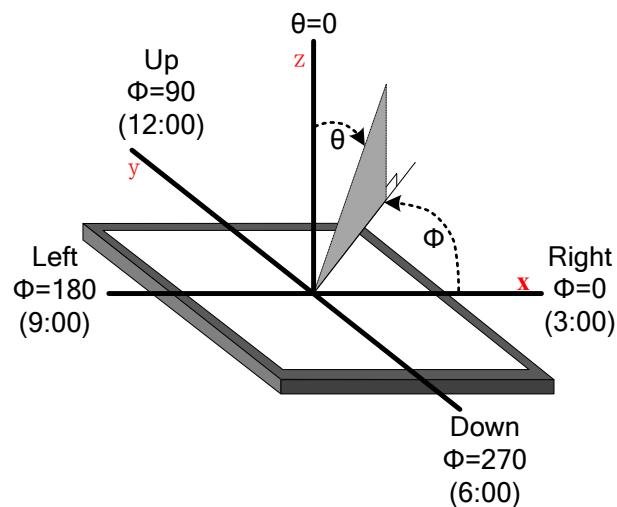


Figure c

FIG.2. The definition of viewing angle



8. LCM INTERFACE DESCRIPTION

Interface NO.	PIN NAME	I/O	DESCRIPTION
1	N/C	Float	No connection,Please float it
2-3	VDD	P	Power supply for digital
4	NC	I	No connected.
5	REST	I	Global reset pin. Active Low. Normally pull high.
6	STBYB	I	Display on/off swich,"H" display ON
7	GND	P	Ground
8	RXIN0-	I/O	LVDS data lane 0-
9	RXIN0+	I/O	LVDS data lane 0+
10	GND	P	Ground
11	RXIN1-	I/O	LVDS data lane 1-
12	RXIN1+	I/O	LVDS data lane 1+
13	GND	P	Ground
14	RXIN2-	I/O	LVDS data lane 2-
15	RXIN2+	I/O	LVDS data lane 2+
16	GND	P	Ground
17	RXCLKIN-	I/O	LVDS clk lane -
18	RXCLKIN+	I/O	LVDS clk lane +
19	GND	P	Ground
20	RXIN3-	I/O	LVDS data lane 3-
21	RXIN3+	I/O	LVDS data lane 3+
22	GND	P	Ground
23	NC	Float	No connection,Please float it
24	BIST	I	Normal Operation/BIST pattern select. Normally pull low BIST = H : BIST(DCLK input is not needed) BIST = L : Normal Operation
25	INSEL	I	In LVDS interface INSEL = L : 8 bit INSEL = H : 6 bit
26	NC	Float	No connection,Please float it
27	GND	P	Ground
28	NC	Float	No connection,Please float it
29	L/R	I	L/R="L" Scan direction from right to left; L/R="H" Scan direction from left to right;
30	U/D	I	U/D="H" Scan direction from down to up; U/D="L" Scan direction from up to down;
31	NC	Float	No connection,Please float it
32-33	LEDK	P	LED Cathode for BL
34	NC	Float	No connection,Please float it
35-36	LEDA	P	LED ANODE for BL
37	XR/NC	Float	No connection,Please float it
38	YD/NC	Float	No connection,Please float it
39	XL/NC	Float	No connection,Please float it
40	YU/NC	Float	No connection,Please float it

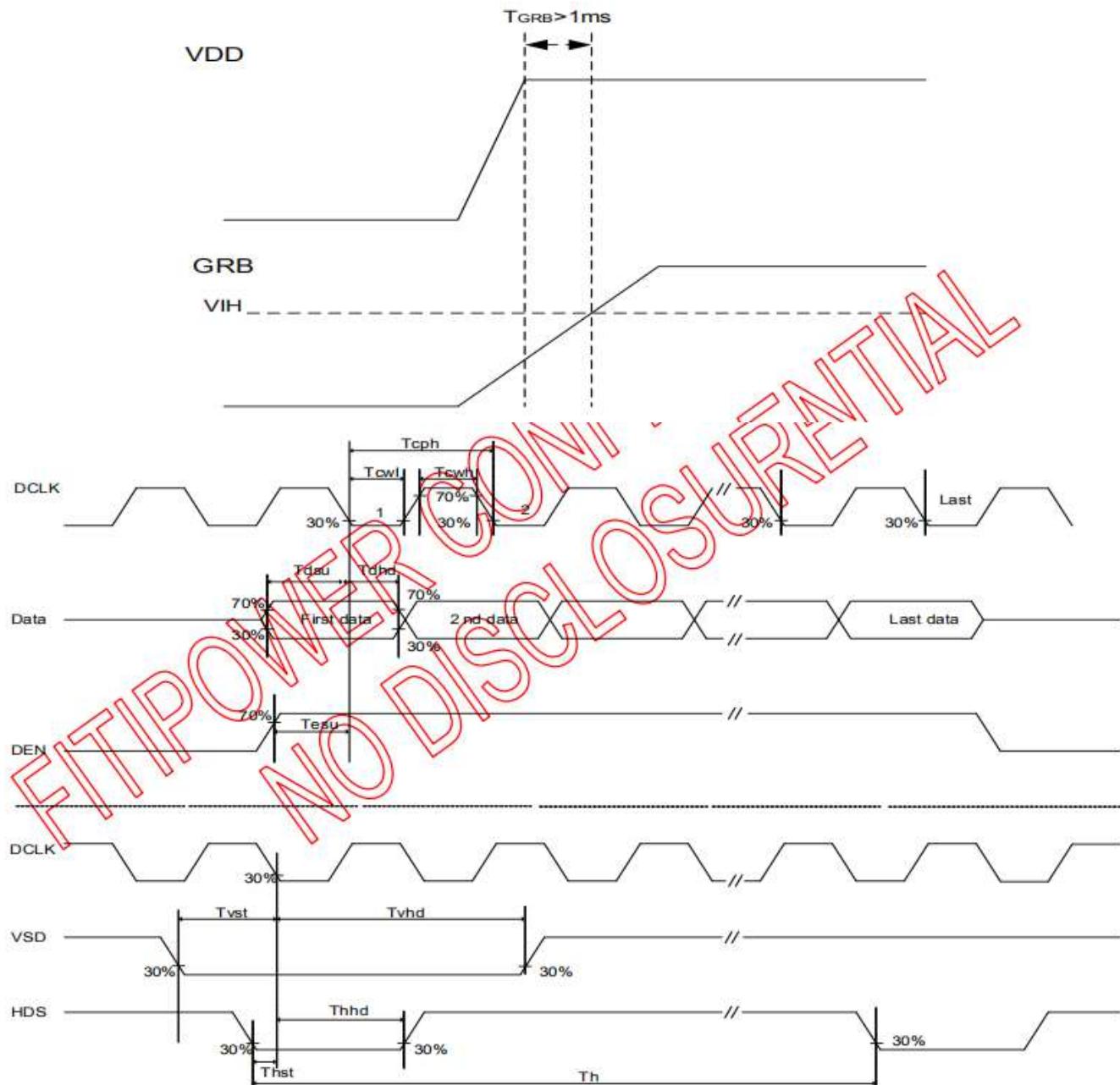
CTP interface description

Interface NO.	NAME	I/O or connect to	DESCRIPTION
1	GND	P	Ground
2	CHG INT	I	State change interrupt
3	RESET	I	Reset low
4	VDD	P	Power
5	SCL	I	Serial interface clock
6	SDA	I/O	Serial interface date

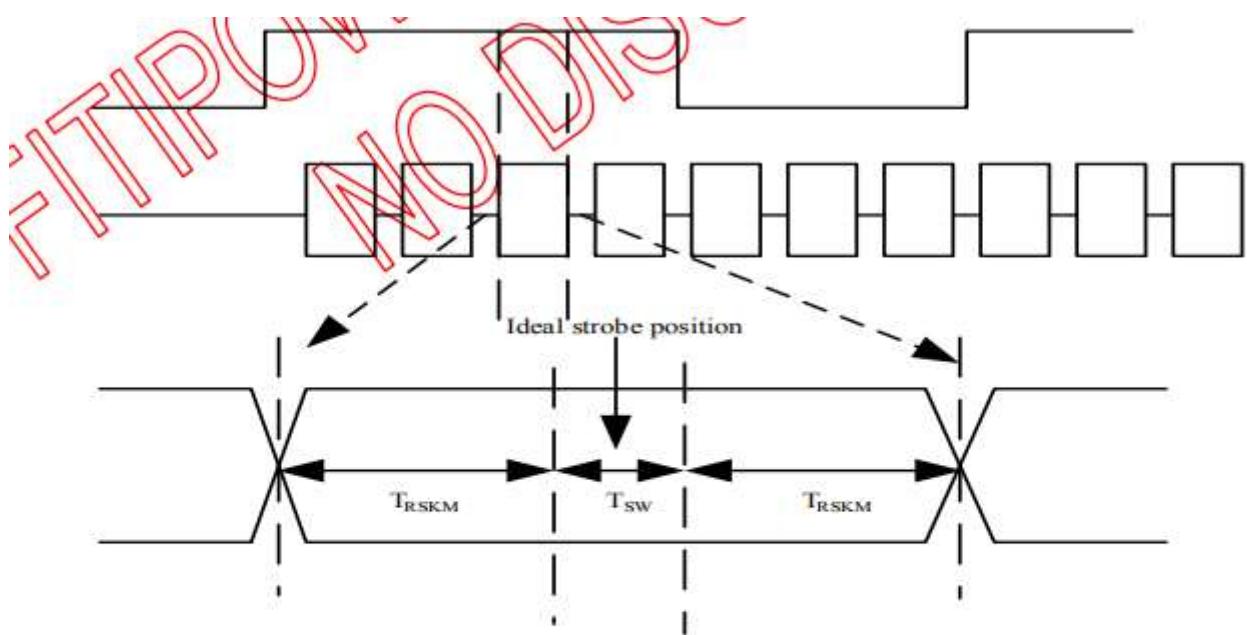
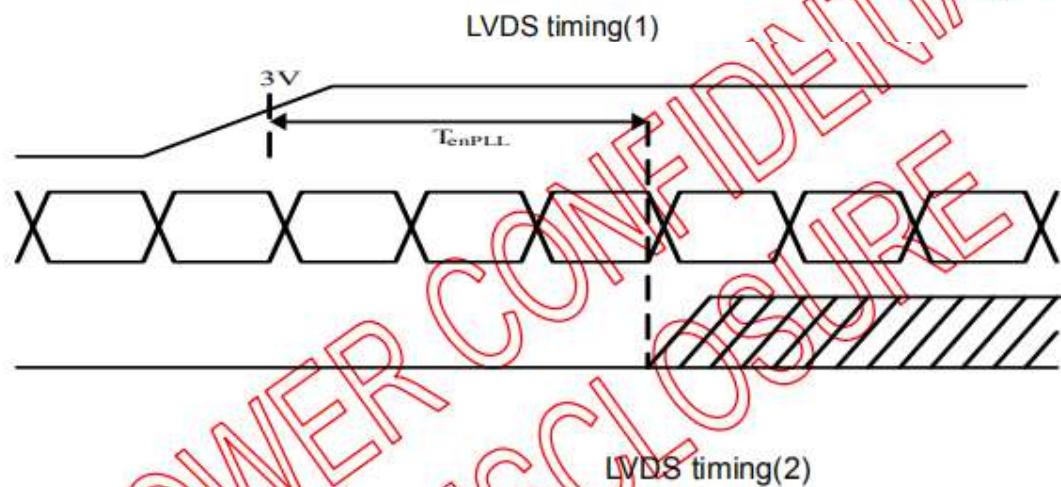
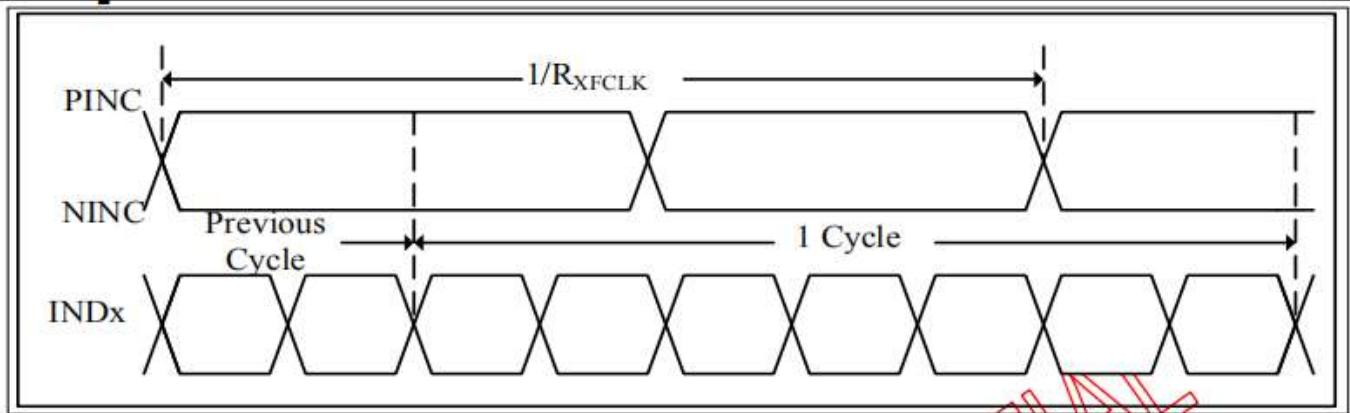
9.AC CHARACTERISTICS

LVDS mode

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Clock Frequency	RxFCLK		20	-	71	MHz
Input data skew margin	TRSKM	$ VID = 400mV$ $RxVCM = 1.2V$ $RxFCLK = 71MHz$	500			ps
Clock High Time	TLVCH			$4/(7 * RxFCLK)$		ns
Clock Low Time	TLVCL			$3/(7 * RxFCLK)$		ns
PLL wake-up-time	TenPLL				150	us



Parallel Input Clock and Data timing

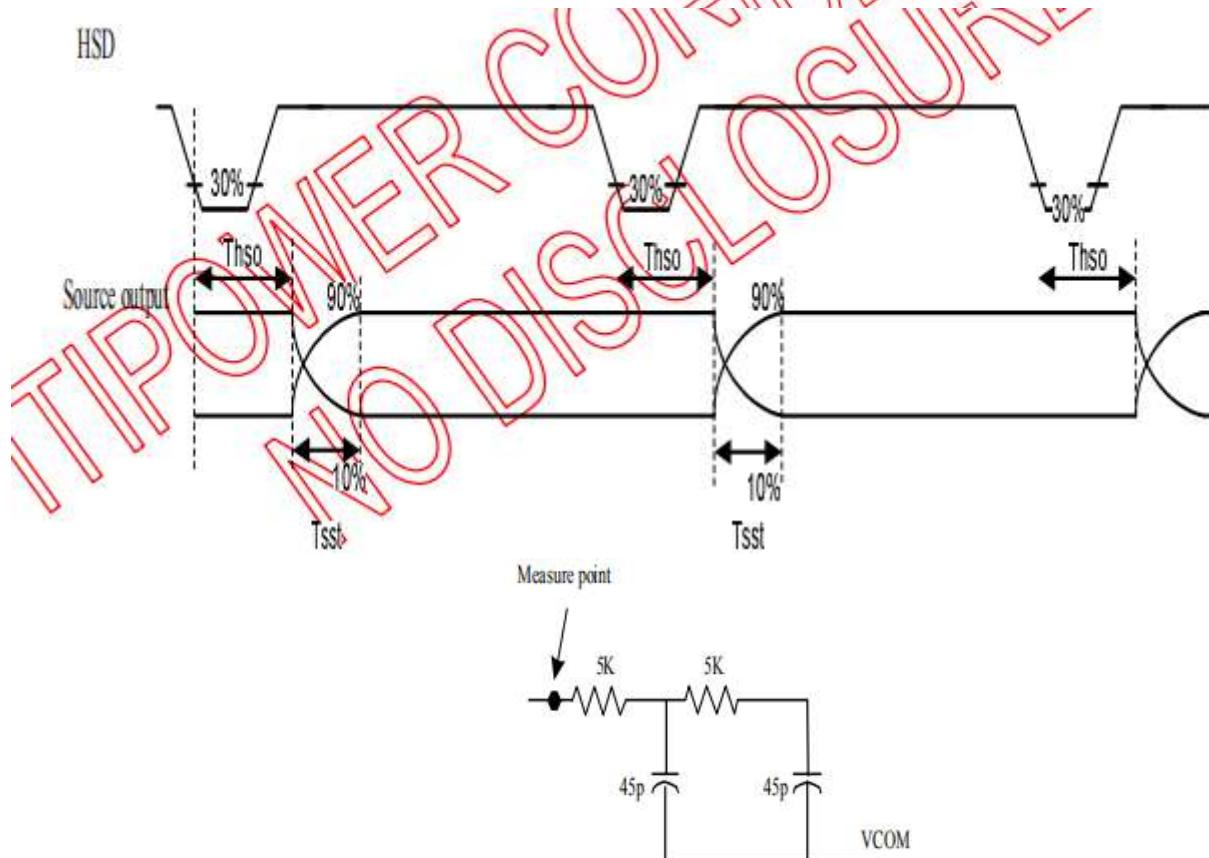


T_{SW} : Receiver strobe position
 T_{RSKM} : Receiver strobe margin

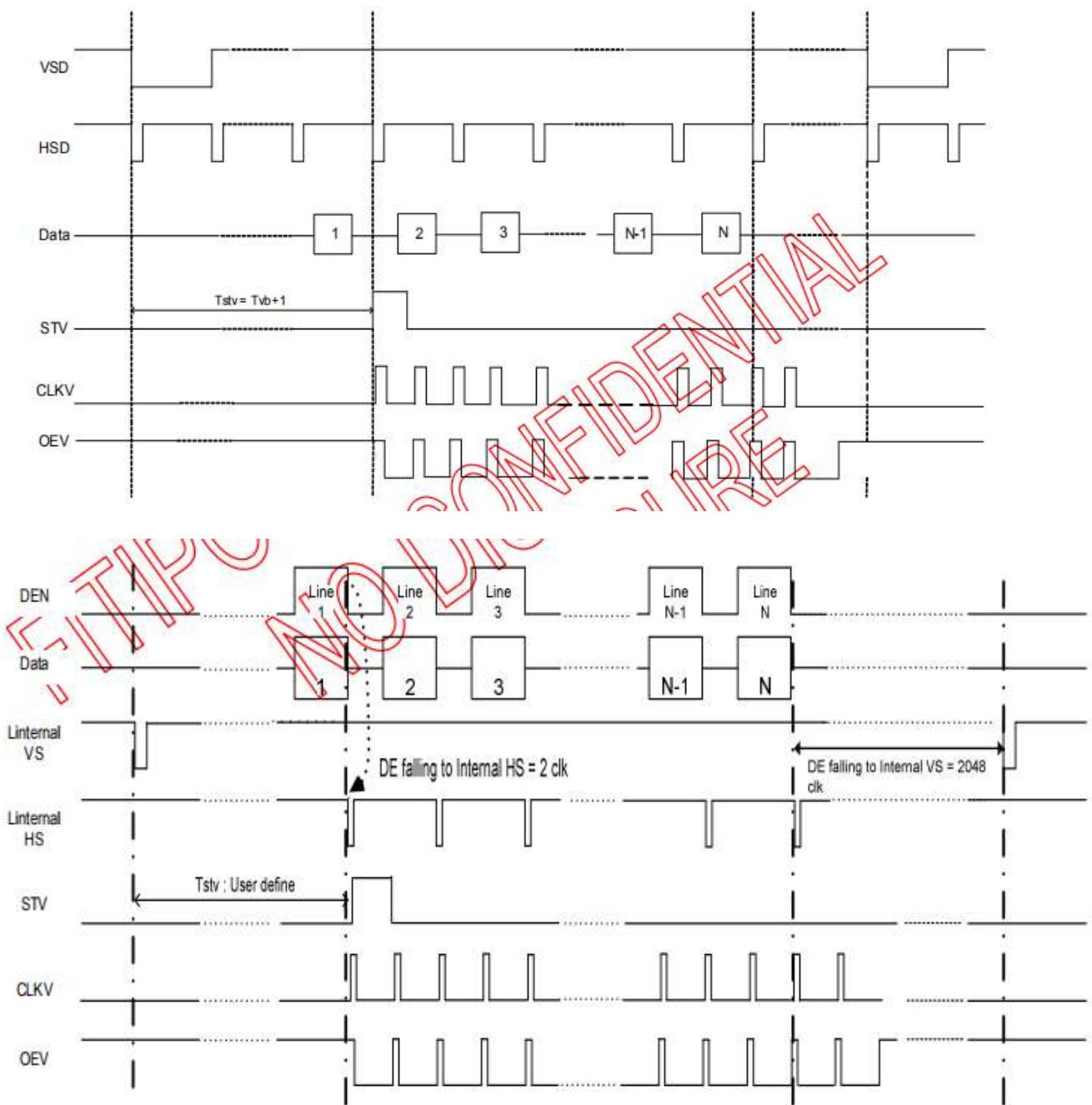
LVDS timing(3)

Output Timing Table

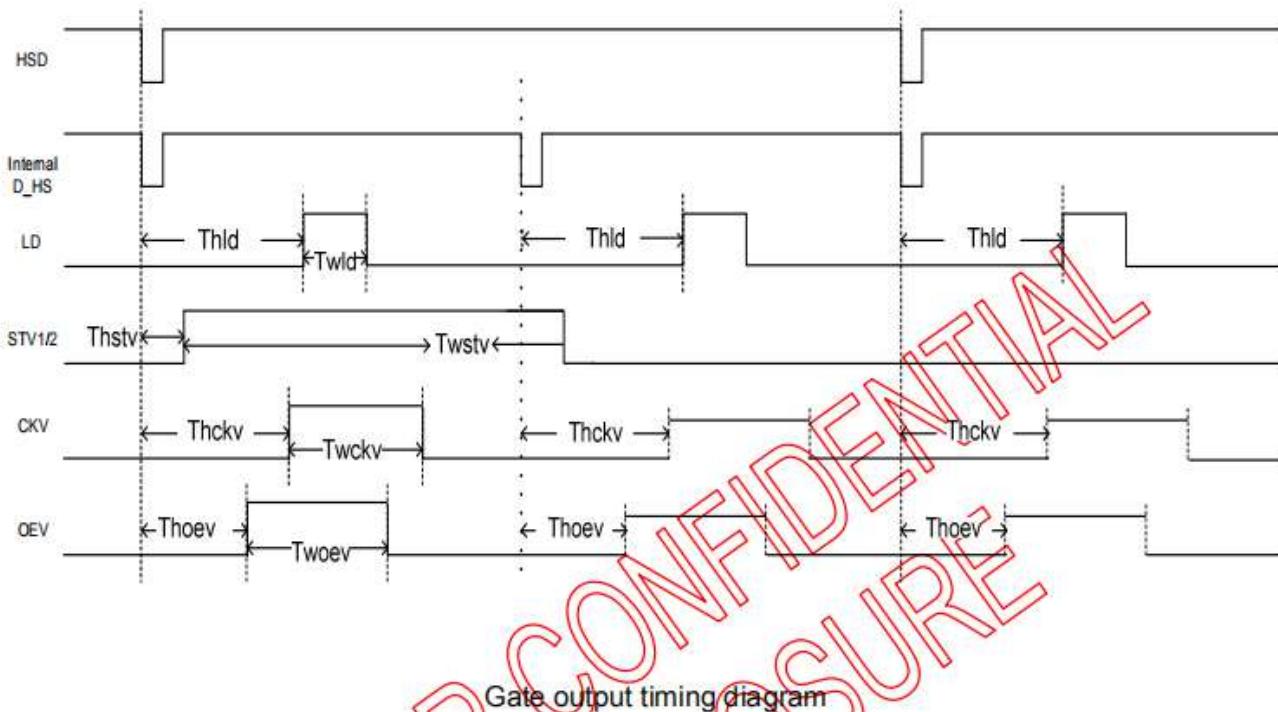
Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
DCLK frequency	Fclk	-	65	71	MHz	VDD =2.3~3.6V
DCLK cycle time	Tclk	14.1	15.4		ns	
DCLK pulse duty	Tcwh	40	50	60	%	Tclk
Time from HSD to Source Output	Thso	-	64	-	DCLK	
Time from HSD to LD	Thld	-	64	-	DCLK	
Time from HSD to STV	Thstv	-	2	-	DCLK	
Time from HSD to CKV	Thckv	-	20	-	DCLK	
Time from HSD to OEV	Thoev	-	4	-	DCLK	
LD pulse width	Twld	-	10	-	DCLK	
CKV pulse width	Twckv	-	66	-	DCLK	
OEV pulse width	Twoev	-	74	-	DCLK	



Vertical Timing Diagram HV mode

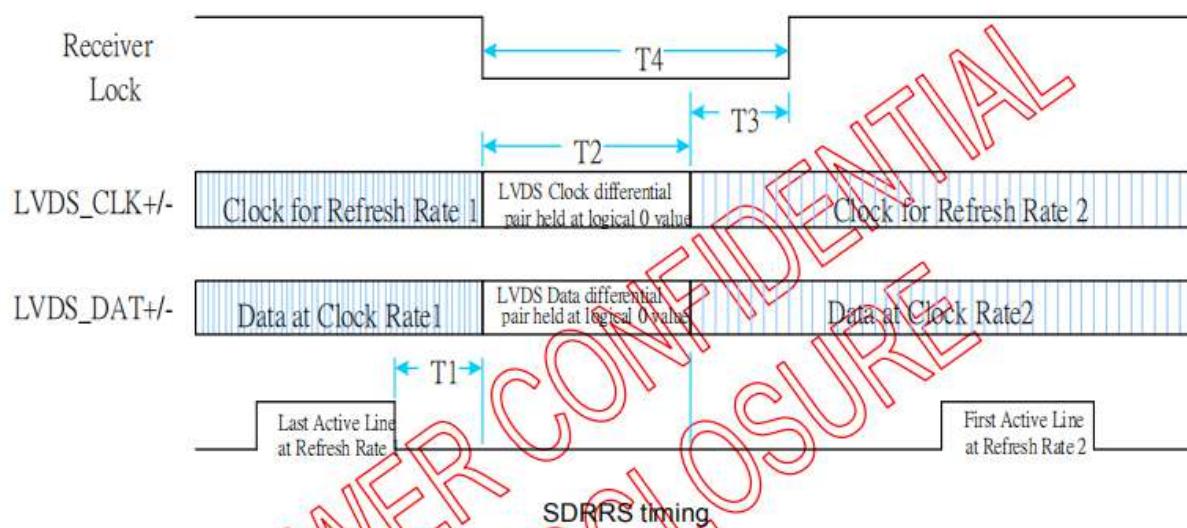


Vertical Timing Diagram DE mode



SDRRS(seamless display refresh rate switching)

When Showing the still picture.it is accept to refresh rate from 60Hz to low refresh rate (for example 40Hz).The purpose is mainly for power saving. INTEL defined a timing chart switch between different refresh rate.Following this timing chart,the switch between different refresh rates is seamless for end user.



T1-Min delay from start of vertical blank to start of timing change:2 lines(HSYNC periods)

T2-Max delay for clock to transition to new frequency:100us

T3-Max receiver lock delay from stable clock. Display specific

T4-Max period during which panel maintains display(T2+T3): Display specific

CTP limiting electrical parameter

(环境温度为 25℃)

参数	最小值	最大值	单位
模拟电源 AVDD28 (参考 AGND)	2.66	3.47	V
VDDIO (参考 DGND)	1.7	3.47	V
数字 I/O 可承受电压	0	3.47	V
模拟 I/O 可承受电压	0	3.47	V
工作温度范围	-40	85	℃
存储温度范围	-40	125	℃
焊接温度 (10 秒钟)		300	℃
ESD 保护电压 (HB Model)	-	±2	KV

CTP AC Characteristics

(环境温度为 25℃, AVDD=2.8V, VDDIO=1.8V)

参数	最小值	典型值	最大值	单位
OSC 振荡频率	59	60	61	MHz
I/O 输出由低到高转换时间	-	-	0.5	ns
I/O 输出由高到低转换时间	-	-	0.5	ns

If you want to know more about CTP, please ask us for CTP specification

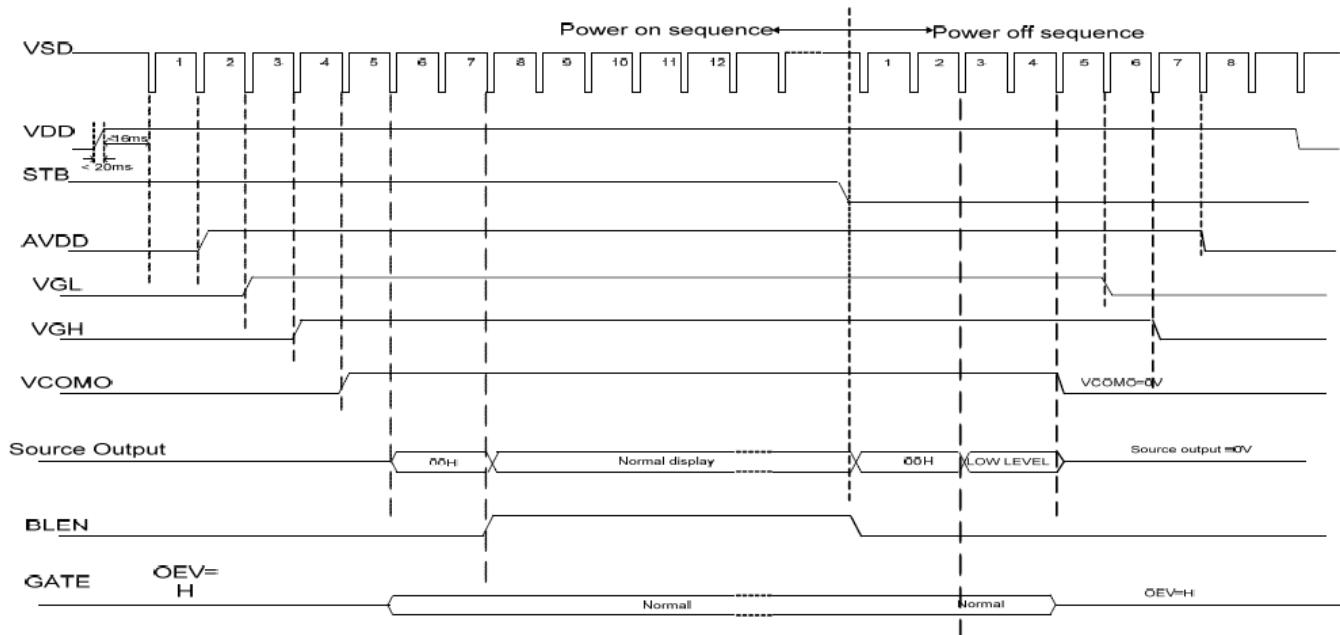
10. POWER SEQUENCE

To prevent the device damage from latch up and Improve subjective display effect, the power ON/OFF sequence shown below must be followed.

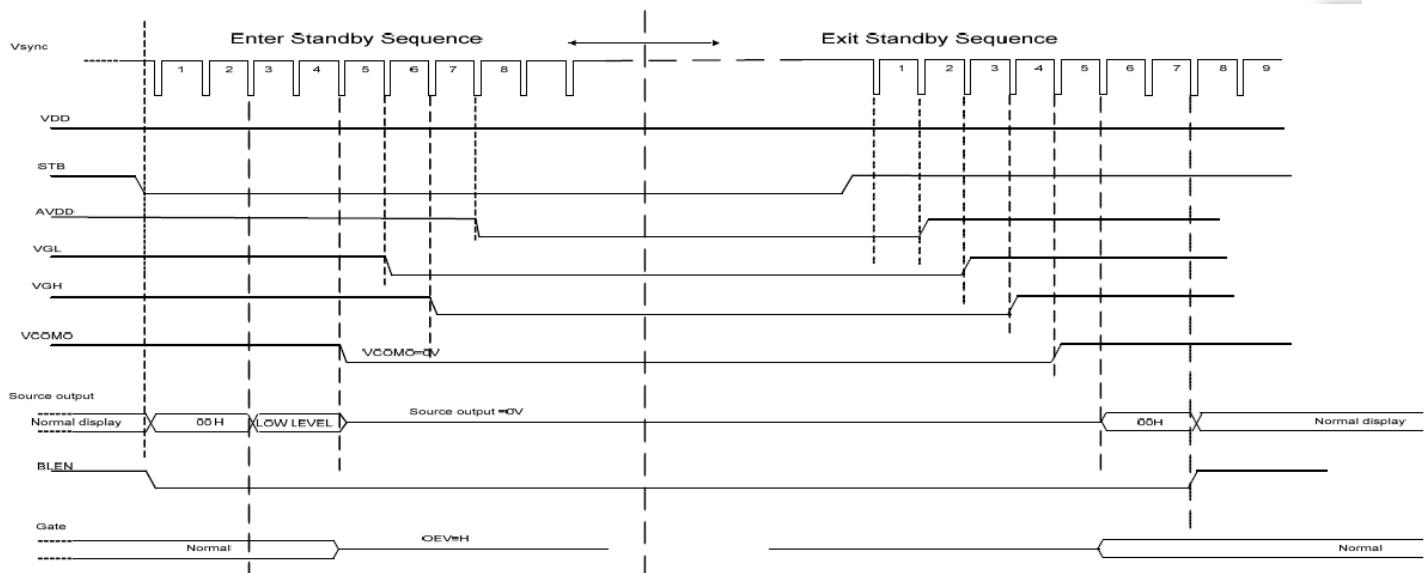
10.1. Power On/Off Sequence

In order to prevent IC from power on reset fail, the rising time (TPOR) of the digital power supply VDD should be maintained within the given specifications. Refer to "AC Characteristics" for more detail on timing.

10.2. Power-On/Off Timing Sequence



Power On/Off timing chart



Enter and Exit Standby Mode timing chart

11. RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition	Inspection after test
1	High Temperature Storage	+80°C/240 hours	
2	Low Temperature Storage	-30°C/240 hours	
3	High Temperature Operating	+70°C/120 hours	
4	Low Temperature Operating	-20°C/120 hours	
5	Temperature Cycle	-30°C ~ 25°C ~ +80°C/10cycles (30min.) (10min.) (30min.)	
6	Damp Proof Test	50°C*90% RH/120 hours	
7	Vibration Test	Frequency : 10Hz~55Hz~10Hz Amplitude :1.5mm, X ,Y ,Z direction for total 3hours (Packing condition)	
8	Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	
9	ESD test	Voltage:±8KV R: 330Ω C: 150pF Air discharge, 10times	

Remark:

- 1.The test samples should be applied to only one test item.
- 2.Sample size for each test item is 3~5pcs.
- 3.For Damp Proof Test, Pure water(Resistance > 10MΩ) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5.EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.
- 7.The finished surface should be free of Drips,Globs,Glue and contamination.
- 8.The paint must adhere to the cover lens and withstand the following test:
Pressure sensitive tape(SCOTCH #610 or equivalent adhesion strength) is applied to the painted surface And then rapidly removed by pulling at a 90 degree angle to the surface; There should be no evidence of paint seriating from the glass.
- 9.After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

12. INSPECTION CRITERION

Refer to the quality standard on the back of the specification

13. HANDLING PRECAUTIONS

13.1 Mounting method

The LCD module consists of two thin glass plates with polarizers which easily be damaged. And since the module is so constructed as to be fixed by utilizing fitting holes in the printed circuit board. Extreme care should be needed when handling the LCD modules.

13.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent [recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (Cl) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (Cl), Sulfur (S) from customer, Responsibility is on customer.

13.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

13.4 Packing

Module employ LCD elements and must be treated as such.

- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

13.5 Caution for operation

• It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.

• An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

• Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's have dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.

• If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.

• A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.

13.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

• Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.

• Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.

• Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.

- .Storing with no touch on polarizer surface by the anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

13.7 Safety

- .It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- .When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

14. PRECAUTION FOR USE

14.1 A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

14.2 On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- .When a question is arisen in this specification
- .When a new problem is arisen which is not specified in this specifications
- .When an inspection specifications change or operating condition change in customer is reported to ODNA, and some problem is arisen in this specification due to the change
- .When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

15. PACKING SPECIFICATION

Please consult our technical department for detail information.